



DESCRIPTION

The MPT5838 Series is a range of fully integrated, compact, direct switching, high voltage solid-state modulator systems. They are specifically designed to drive the e2v technologies range of low power linac magnetrons, and utilise e2v technologies' patented AMM solid-state modular technology.

The modulator, when combined with an e2v technologies linac magnetron, provides a reliable, high energy, pulsed microwave source from a prime power input.

The system is constructed in two sub-assemblies, which are designed to be mounted in a variety of orientations.

MAXIMUM RATINGS

Electrical (see note 1)

| | | |
|---|------------|------|
| Output power (peak) | 7.0 | MW |
| Output power (mean) | 8 | kW |
| Peak output voltage | 46 | kV |
| Peak output current | 130 | A |
| Heater current (see note 2) | 15 | A dc |
| Heater voltage (see note 2) | 20 | V dc |
| Heater power (see note 2) | 270 | W |
| Pulse width (user controlled) | 1.5 to 5.0 | µs |
| Pulse repetition frequency | 6 to 1000 | Hz |
| Prime power (3-phase) | 440 | V |

Mechanical

| | | |
|---|--------------------|----|
| Overall dimensions (maximum): | | |
| modulator | 340 x 530 x 985 mm | |
| power and control unit (19" rack) | 311 x 483 x 541 mm | |
| Net weight: | | |
| modulator | 102 | kg |
| power and control unit | 70 | kg |

Cooling

Cooling liquid (water) in the temperature range 10 to 40 °C.

Environmental

| | | |
|---------------------|------------|----|
| Temperature range: | | |
| operating | +10 to +50 | °C |
| storage | -25 to +70 | °C |

| | | |
|--|----|-------|
| Relative humidity (non-condensing): | | |
| for temperatures up to 31 °C | 80 | % max |
| for temperatures up to 45 °C | 20 | % min |
| Vibration (20 to 200 Hz) | 4 | g |
| Shock (11 ms, half-sine) | 25 | g |

The unit is capable of operating in a low pressure environment, down to 700 mbar.

ELECTRICAL INPUT CHARACTERISTICS

| | Min | Typ | Max | |
|------------------------------------|-----|-----|-----|-------|
| Input 3-phase supply | 360 | 400 | 440 | V rms |
| Supply frequency | 47 | 50 | 63 | Hz |
| Supply current per phase | - | - | 30 | A rms |
| Inrush current per phase | - | - | 30 | A rms |
| Power factor | 0.9 | - | - | |
| Single-phase supply | 220 | - | 250 | V rms |
| Single-phase current | - | - | 3.5 | A rms |
| Earth leakage current | - | 3 | - | mA |

TYPICAL OPERATING CONDITIONS

| | | |
|---------------------------------------|-----|-------|
| Anode voltage | 44 | kV |
| Anode current | 110 | A |
| Pulse length | 4.5 | µs |
| Pulse repetition frequency | 300 | Hz |
| Rate of rise of voltage | 180 | kV/µs |
| Heater current (see note 2) | 10 | A dc |
| Heater voltage (see note 2) | 12 | V dc |
| Heater power (see note 2) | 120 | W |

PULSE PERFORMANCE PARAMETERS

| | Min | Typ | Max | |
|--|-----|-----|-----|----|
| Pulse current ripple/droop (see note 3) | - | 2.0 | - | % |
| Pulse current overshoot | - | - | 5.0 | % |
| Peak current rise time (10 - 90%) | - | 0.2 | - | µs |
| Peak current fall time (90 - 10%) | - | - | 1.0 | µs |
| Voltage fall time (to 50%) | - | - | 3.0 | µs |
| Voltage fall time (to 10%) | - | - | 15 | µs |
| Back-swing voltage | - | 0 | 10 | kV |
| Amplitude jitter (pulse-pulse) | - | - | 0.1 | % |
| Warm-up variation (0 - 2 s) | - | - | 3.0 | % |
| Long-term stability | - | 0.1 | - | % |

NOTES

1. Ratings do not all apply simultaneously.
2. The heater supply is current controlled, with automatic turn-down determined by the magnetron type and mean power.
3. Droop at 120 A. This is a function of operating level and pulse width.

MODULATOR INTERFACE

Electrical Output Interface

The modulator-magnetron interface connections shall be mounted within an RF-tight enclosure.

Guidance on specific mounting and interface arrangements is available on request.

Monitoring of the magnetron peak voltage and current is provided.

| | Scale | Connector |
|----------------------|-----------|-----------------|
| Peak voltage monitor | 10 kV/1 V | BNC |
| Peak current monitor | 100 A/1 V | BNC |
| Filament voltage | | via RS485 (opt) |
| Filament current | | via RS485 (opt) |

The MPT5838 manual contains further details of the control system interface including status information, trips and options.

Electrical Input Interface

Termination of the three-phase mains supply is via terminals.

The control interface provides the following functions:

- a) Standby power on/off.
- b) Heaters on/off - Current control pre-set with filament turn-down requirements.
- c) HV pulse on/off - control of peak anode current amplitude via analogue voltage as default.
- d) Provision for external input of pulse width and pulse repetition frequency.
- e) Interlock/fault status.
- f) Provision for remote/local control (RS485).

Interlocks and Fault Indication

- a) Separate external interlocks to prevent HV operation for both local and remote operation unless safe to do so.
- b) Heater interlock to prevent HV pulse operation during a pre-set interval following application of the heater power. The heater interlock interval is started on detection of heater current.

- c) The magnetron arc detector inhibits HV pulse operation after a pre-set number of arcs for a short period of time.

The modulator is self-protecting under normal operating and fault conditions, including magnetron arcing, excessive duty and component overheating.

Provision is made for both local and remote indication of all interlocks.

HEALTH AND SAFETY HAZARDS

e2v technologies devices are safe to handle and operate, provided that the relevant precautions stated herein are observed. e2v technologies does not accept responsibility for damage or injury resulting from the use of electronic devices it produces. Equipment manufacturers and users must ensure that adequate precautions are taken. Appropriate warning labels and notices must be provided on equipments incorporating e2v technologies devices and in operating manuals.



High Voltage

Equipment must be designed so that personnel cannot come into contact with high voltage circuits. All high voltage circuits and terminals must be enclosed and fail-safe interlock switches must be fitted to disconnect the primary power supply and discharge all high voltage capacitors and other stored charges before allowing access. Interlock switches must not be bypassed to allow operation with access doors open.



RF Radiation

Personnel must not be exposed to excessive RF radiation. All RF connectors must be correctly fitted before operation so that no leakage of RF energy can occur and the RF output must be coupled efficiently to the load. It is particularly dangerous to look into open waveguide or coaxial feeders while the device is energised. Screening of the cathode sidearm of high power magnetrons may be necessary.



X-Ray Radiation

High voltage magnetrons emit a significant intensity of X-rays not only from the cathode sidearm but also from the output waveguide. These rays can constitute a health hazard unless adequate shielding for X-ray radiation is provided. This is a characteristic of all magnetrons and the X-rays emitted correspond to a voltage much higher than that of the anode.

ADDITIONAL HV SAFETY

The following access interlocks shall be provided if required:

- a) All capacitors shall be fitted with a means of removing the stored energy to below 50 V after one minute from removal of the energising source. This may be accomplished by a bleed resistor or active crowbar.
- b) All HV parts shall be mounted within a grounded enclosure and all connections to HV components shall be made with HV shielded cable.
- c) Non-current carrying metal parts shall be grounded.
- d) Access to voltages of 50 V dc or 25 V ac shall be controlled by a physical barrier.

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